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SCOPE: DUAL POWER MOSFET DRIVER

Device Type	Generic Number	Circuit Function
01	MAX4426M(x)/883B	Dual High-speed Inverting MOSFET Driver
02	MAX4427M(x)/883B	Dual High-speed Noninverting MOSFET Driver
03	MAX4428M(x)/883B	Dual High-speed Inverting/Noninverting MOSFET Driver

Case Outline(s). The case outlines shall be designated in Mil-Std-1835 and as follows:

Outline Letter	Mil-Std-1835	Case Outline	Package Code
JA	GDIP1-T8 or CDIP2-T8	8 LEAD CERDIP	J8
LP	CQCC1-N20	20 Leadless Carrier	LCC

Absolute Maximum Ratings

Supply Voltage V_{DD} to GND 20V
Input Voltage .....V_{DD} +0.3V to GND -0.3V

Lead Temperature (soldering, 10 seconds) ..... +300°C
Storage Temperature ..... -65°C to +150°C

Continuous Power Dissipation ..... T_A=+70°C
8 pin CERDIP(derate 8.0mW/°C above +70°C) 640mW
20 pin LCC(derate 9.1mW/°C above +70°C) 727mW
Junction Temperature T_J ..... +150°C
Thermal Resistance, Junction to Case, ΘJC
8 pin CERDIP..... 55°C/W
20 pin LCC ..... 20°C/W
Thermal Resistance, Junction to Ambient, ΘJA:
8 pin CERDIP..... 125°C/W
20 pin LCC ..... 110°C/W

Recommended Operating Conditions

Ambient Operating Range (T_A) ..... -55°C to +125°C
Supply Voltage Range ..... 4.5V≤V_{DD}≤18V

	Package	ORDERING INFORMATION:
01	8 pin CERDIP	MAX4426MJA/883B
01	20 pin LCC	MAX4426MLP/883B
02	8 pin CERDIP	MAX4427MJA/883B
02	20 pin LCC	MAX4427MLP/883B
03	8 pin CERDIP	MAX4428MJA/883B
03	20 pin LCC	MAX4428MLP/883B

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TABLE 1. ELECTRICAL TESTS:

TEST	Symbol	CONDITIONS -55 °C <=T_A<= +125°C +4.5V≤V_{DD}≤18V Unless otherwise specified	Group A Subgroup	Device type	Limits Min	Limits Max	Units
Logic 1 Input Voltage	V_{IH}		1,2,3	All	2.4		V
Logic 0 Input Voltage	V_{IL}		1,2,3	All		0.8	V
Input Current	I_{IN}	V_{IN} =0V to 18V	1,2,3	All	-1	1	µA
Output High Voltage	V_{OH}	No Load	1,2,3	All	V_{DD}-25		mV
Output Low Voltage	V_{OL}	No Load	1,2,3	All		25	mV
Output Resistance	R_{OUT}	V_{DD}=18V, I_{LOAD}=10mA, V_{IN}=0.8V for inverting stages, V_{IN}=2.4V for noninverting stages	1 2,3	All		10 12	Ω
Output Resistance	R_{OUT}	V_{DD}=18V, I_{OUT}=10mA, V_{IN}=0.8V for noninverting stages V_{IN}=2.4V for inverting stages	1 2,3	All		10 12	Ω
Power Supply Current	I_{S1}	V_{IN}=+3V, both inputs	1 2,3	01		4.5 8.0	mA
Power Supply Current	I_{S2}	V_{IN}=0V, both inputs	1 2,3	01		0.4 0.6	mA
Rise Time NOTE 1	t_R		9 10,11	All		30 40	ns
Fall Time NOTE 1	t_F		9 10,11	All		30 40	ns
Delay Time NOTE 1	t_{D1}		9 10,11	All		30 40	ns
Delay Time NOTE 1	t_{D2}		9 10,11	All		50 60	ns

NOTE 1: Guaranteed by design.

TERMINAL CONNECTIONS FOR 01, 02, 03.

8 PIN CERDIP				20 PIN LCC							
	01	02	03		01	02	03		01	02	03
1	NC	NC	NC	1	NC	NC	NC	11	NC	NC	NC
2	INA	INA	INA	2	NC	NC	NC	12	NC	NC	NC
3	GND	GND	GND	3	NC	NC	NC	13	NC	NC	NC
4	INB	INB	INB	4	INA	INA	INA	14	$\overline{\text{OUTB}}$	OUTB	OUTB
5	$\overline{\text{OUTB}}$	OUTB	OUTB	5	NC	NC	NC	15	NC	NC	NC
6	V_{DD}	V_{DD}	V_{DD}	6	GND	GND	GND	16	V_{DD}	V_{DD}	V_{DD}
7	$\overline{\text{OUTA}}$	OUTA	$\overline{\text{OUTA}}$	7	NC	NC	NC	17	NC	NC	NC
8	NC	NC	NC	8	INB	INB	INB	18	$\overline{\text{OUTA}}$	OUTA	$\overline{\text{OUTA}}$
				9	NC	NC	NC	19	NC	NC	NC
				10	NC	NC	NC	20	NC	NC	NC

QUALITY ASSURANCE

Sampling and inspection procedures shall be in accordance with MIL-Prf-38535, Appendix A as specified in Mil-Std-883.

Screening shall be in accordance with Method 5004 of Mil-Std-883. Burn-in test Method 1015:

1. Test Condition, A, B, C, or D.
2. TA = +125°C minimum.
3. Interim and final electrical test requirements shall be specified in Table 2.

Quality conformance inspection shall be in accordance with Method 5005 of Mil-Std-883, including Groups A, B, C, and D inspection.

Group A inspection:

1. Tests as specified in Table 2.
2. Selected subgroups in Table 1, Method 5005 of Mil-Std-883 shall be omitted.

Group C and D inspections:

a. End-point electrical parameters shall be specified in Table 1.
b. Steady-state life test, Method 1005 of Mil-Std-883:
   1. Test condition A, B, C, D.
   2. TA = +125°C, minimum.
   3. Test duration, 1000 hours, except as permitted by Method 1005 of Mil-Std-883.

TABLE 2. ELECTRICAL TEST REQUIREMENTS

Mil-Std-883 Test Requirements	Subgroups per Method 5005, Table 1
Interim Electric Parameters Method 5004	1
Final Electrical Parameters Method 5005	1*, 2, 3, 9, 10, 11
Group A Test Requirements Method 5005	1, 2, 3, 9, 10, 11
Group C and D End-Point Electrical Parameters Method 5005	1

* PDA applies to Subgroup 1 only.